



DUAL N-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

V _{(BR)DSS}	R _{DS(ON)} max	I _D max T _A = +25°C
001/	$30m\Omega$ @ $V_{GS} = 10V$	6.2A
30V	42mΩ @ V _{GS} = 4.5V	5.2A

Description and Applications

This MOSFET is designed to minimize the on-state resistance $(R_{DS(ON)})$ and yet maintain superior switching performance, making it ideal for high-efficiency power management applications.

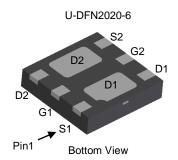
- Body Control Electronics
- Power Management Functions
- DC-DC Converters

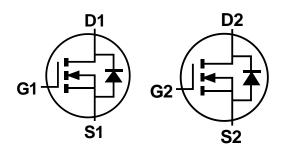
Features and Benefits

- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: U-DFN2020-6
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish NiPdAu Annealed over Copper Leadframe.
 Solderable per MIL-STD-202, Method 208 ⁽⁴⁾
- Terminals Connections: See Diagram Below
- Weight: 0.0065 grams (Approximate)





Internal Schematic

Ordering Information (Note 4)

Part Number	Case	Packaging
DMN3032LFDB-7	U-DFN2020-6	3,000/Tape & Reel
DMN3032LFDB-13	U-DFN2020-6	10,000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information

U-DFN2020-6



N5 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: C = 2015) M = Month (ex: 9 = September)

Date Code Key

Year	201	5	2016		2017	20	18	2019		2020	2	2021
Code	С		D		Е		=	G		Н		
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Drain-Source Voltage		V_{DSS}	30	V	
Gate-Source Voltage		V_{GSS}	±20	V	
Continuous Drain Current (Note 6) $V_{GS} = 10V$ Steady $T_A = +25^{\circ}C$ State $T_A = +75^{\circ}C$			I _D	6.2 5.0	А
Maximum Continuous Body Diode Forward Curren	t (Note 6)	I _S	2	Α	
Pulsed Drain Current (10μs Pulse, Duty Cycle = 1%	6)	I _{DM}	25	Α	
Avalanche Current (Note 7) L = 0.1mH		I _{AS}	12	Α	
Avalanche Energy (Note 7) L = 0.1mH		E _{AS}	10	mJ	

Thermal Characteristics

Characteristic		Symbol	Value	Unit	
Total Power Dissipation (Note 5)		P_{D}	1.0	W	
The small Besietenes I lungtion to Ambient (Nets 5)		D.	127	°C/W	
Thermal Resistance, Junction to Ambient (Note 5)	t<10s	$R_{\theta JA}$	75	C/VV	
Total Power Dissipation (Note 6)		P_{D}	1.7	W	
Thermal Resistance, Junction to Ambient (Note 6)	Steady state	D	72		
t<10s		$R_{\theta JA}$	43	°C/W	
Thermal Resistance, Junction to Case (Note 6)		$R_{ heta JC}$	9		
Operating and Storage Temperature Range		$T_{J_1}T_{STG}$	-55 to +150	°C	

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

<u> </u>	T		_				
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 8)							
Drain-Source Breakdown Voltage	BV _{DSS}	30	-	-	V	$V_{GS} = 0V, I_D = 250\mu A$	
Zero Gate Voltage Drain Current T _J = +25°C	I _{DSS}	1	-	1.0	μΑ	$V_{DS} = 30V, V_{GS} = 0V$	
Zero Gate Voltage Drain Current T _J = +150°C (Note 9)	I _{DSS}	1	-	100	μΑ	$V_{DS} = 30V, V_{GS} = 0V$	
Gate-Source Leakage	I _{GSS}	-	-	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 8)							
Gate Threshold Voltage	V _{GS(TH)}	1.0	1.5	2.0	V	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	
Static Drain-Source On-Resistance	D		25	30	mΩ	$V_{GS} = 10V, I_D = 5.8A$	
Static Dialit-Source Off-Resistance	R _{DS(ON)}	-	30	42	11122	$V_{GS} = 4.5V, I_D = 4.8A$	
Diode Forward Voltage	V _{SD}	-	0.75	1.2	V	$V_{GS} = 0V$, $I_S = 1A$	
DYNAMIC CHARACTERISTICS (Note 9)							
Input Capacitance	C _{iss}	-	500	-	pF	45)()(
Output Capacitance	Coss	-	52	-	pF	$V_{DS} = 15V, V_{GS} = 0V,$ -f = 1.0MHz	
Reverse Transfer Capacitance	C _{rss}	-	44	-	pF	1 = 1.0WH12	
Gate Resistance	Rg	-	2.3	-	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge (V _{GS} = 4.5V)	Q_g	-	5.0	-	nC		
Total Gate Charge (V _{GS} = 10V)	Qg	-	10.6	-	nC	\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \	
Gate-Source Charge	Q _{gs}	-	1.3	-	nC	$V_{DS} = 15V, I_{D} = 5.8A$	
Gate-Drain Charge	Q_{gd}	-	1.8	-	nC		
Turn-On Delay Time	t _{D(ON)}	-	2.2	-	ns		
Turn-On Rise Time	t _R	-	2.6	-	ns	$V_{DD} = 15V, V_{GS} = 10V,$	
Turn-Off Delay Time	t _{D(OFF)}	-	9.7	-	ns	$R_L = 2.6\Omega$, $R_G = 3\Omega$	
Turn-Off Fall Time	t _F	-	2.0	-	ns		

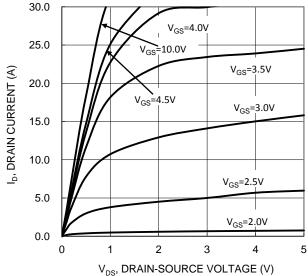
 Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
 Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate. Notes:

7. I_{AS} and E_{AS} ratings are based on low frequency and duty cycles to keep $T_J = +25$ °C.

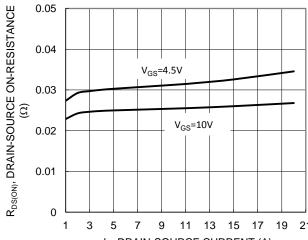
8. Short duration pulse test used to minimize self-heating effect.

9. Guaranteed by design. Not subject to product testing.





V_{DS}, DRAIN-SOURCE VOLTAGE (V) Figure 1. Typical Output Characteristic



I_D, DRAIN-SOURCE CURRENT (A) Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

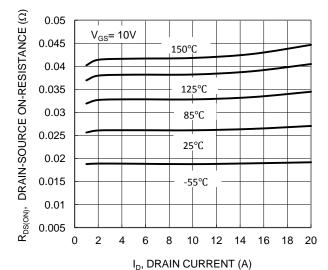
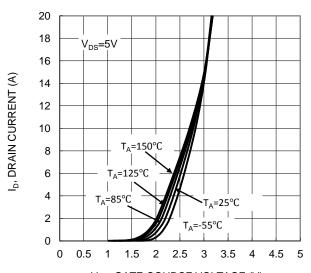
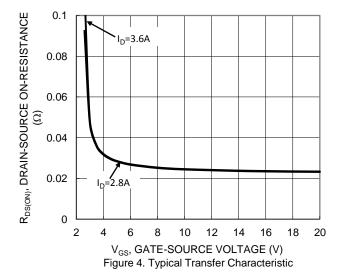


Figure 5. Typical On-Resistance vs. Drain Current and Temperature



 $V_{\rm GS},\, {\rm GATE}\text{-}{\rm SOURCE}\,\, {\rm VOLTAGE}\,\, ({\rm V})$ Figure 2. Typical Transfer Characteristic



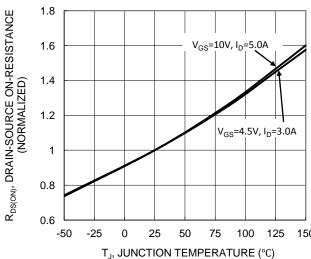
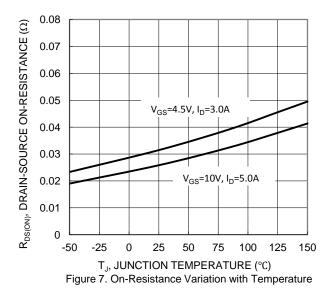
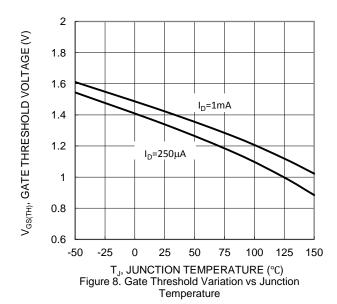
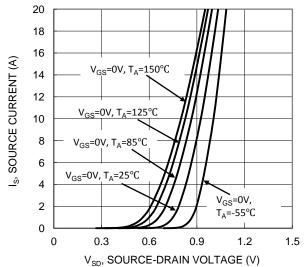


Figure 6. On-Resistance Variation with Temperature









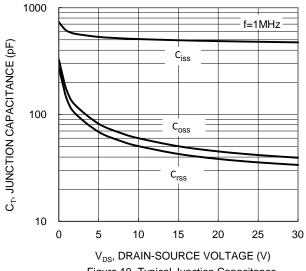
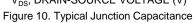
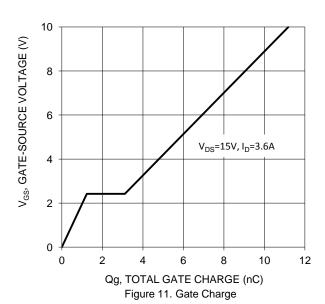


Figure 9. Diode Forward Voltage vs. Current





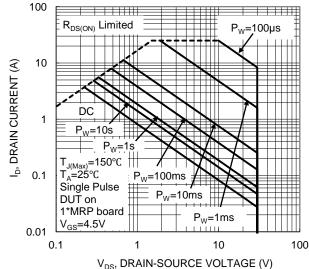
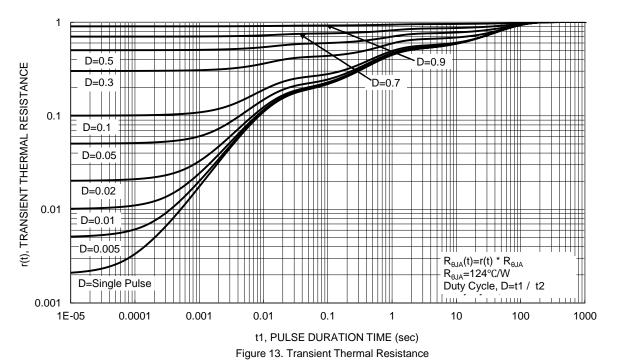


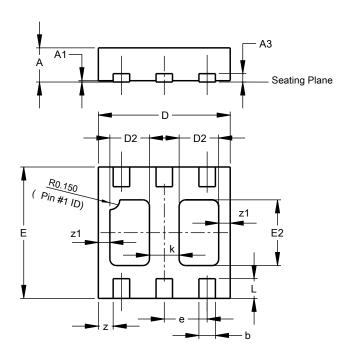
Figure 12. SOA, Safe Operation Area





Package Outline Dimensions

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.

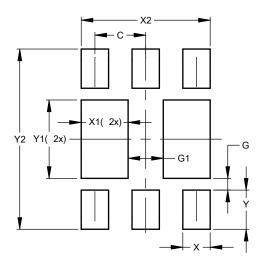


U-DFN2020-6									
Type B									
Dim	Min	Min Max Typ							
Α	0.545	0.605	0.575						
A1	0.00	0.05	0.02						
A3	-	-	0.13						
b	0.20	0.30	0.25						
D	1.95	2.075	2.00						
D2	0.50 0.70		0.60						
е	-	-	0.65						
Е	1.95	2.075	2.00						
E2	0.90	1.10	1.00						
k	-	-	0.45						
L	0.25	0.35	0.30						
Z	-	-	0.225						
z1	-	-	0.15						
All	All Dimensions in mm								



Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)				
С	0.650				
G	0.150				
G1	0.450				
Х	0.350				
X1	0.600				
X2	1.650				
Y	0.500				
Y1	1.000				
Y2	2.300				

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